# 74HC251; 74HCT251

8-input multiplexer; 3-state
Rev. 6 — 8 February 2021

**Product data sheet** 

### 1. General description

The 74HC251; 74HCT251 is an 8-bit multiplexer with eight binary inputs (I0 to I7), three select inputs (S0 to S2) and an output enable input ( $\overline{OE}$ ). The select inputs select one of the eight binary inputs and route it to the complementary outputs (Y and  $\overline{Y}$ ). A HIGH on  $\overline{OE}$  causes the outputs to assume a high-impedance OFF-state. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

#### 2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Complies with JEDEC standards:
  - JESD8C (2.7 V to 3.6 V)
  - JESD7A (2.0 V to 6.0 V)
- Input levels:
  - For 74HC251: CMOS level
  - For 74HCT251: TTL level
- · Non-inverting data path
- · ESD protection:
- HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

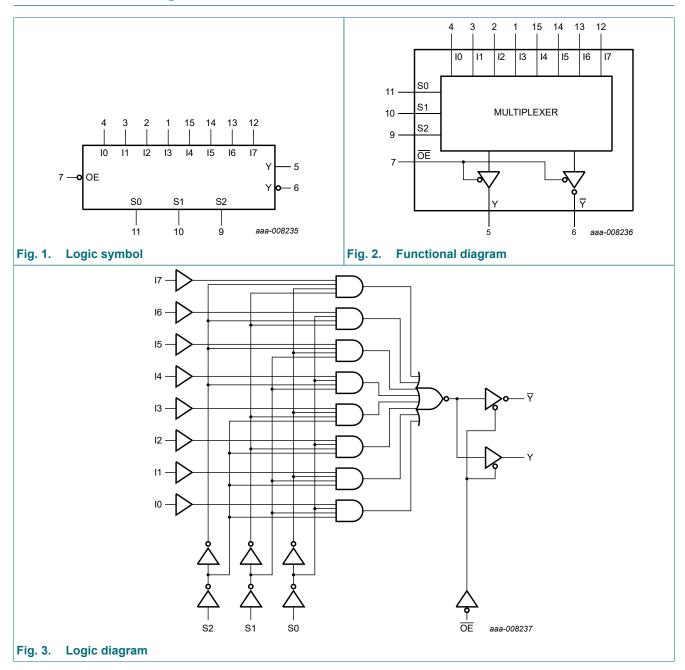
# 3. Ordering information

#### **Table 1. Ordering information**

Type number	Package										
	Temperature range	Name	Description	Version							
74HC251D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads;	SOT109-1							
74HCT251D			body width 3.9 mm								
74HC251PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package;	SOT403-1							
74HCT251PW			16 leads; body width 4.4 mm								

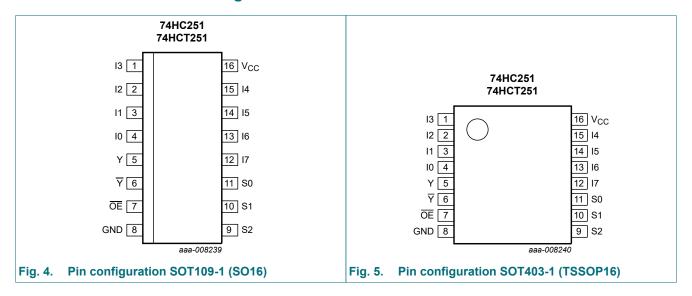


# 4. Functional diagram



# 5. Pinning information

#### 5.1. Pinning



#### 5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
10, 11, 12, 13, 14, 15, 16, 17	4, 3, 2, 1, 15, 14, 13, 12	data inputs
Υ	5	multiplexer output
₹	6	complementary multiplexer output
<del>OE</del>	7	output enable input (active LOW)
GND	8	ground (0 V)
S0, S1, S2	11, 10, 9	common data select inputs
V <sub>CC</sub>	16	supply voltage

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# 6. Functional description

#### Table 3. Function table

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = don't \ care; \ Z = high-impedance \ OFF-state.$ 

Input											Outp	Output	
OE	S2	S1	S0	10	I1	12	13	14	15	16	17	Y	Y
Н	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Z	Z
L	L	L	L	L	Х	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	L	Н	Х	Х	Х	Х	Х	Х	Х	L	Н
L	L	L	Н	Х	L	Х	Х	Х	Х	Х	Х	Н	L
L	L	L	Н	Х	Н	Х	Х	Х	Х	Х	Х	L	Н
L	L	Н	L	Х	Х	L	Х	Х	Х	Х	Х	Н	L
L	L	Н	L	Х	X	Н	Х	Х	Х	Х	Х	L	Н
L	L	Н	Н	Х	Х	Х	L	Х	Х	Х	Х	Н	L
L	L	Н	Н	Х	X	Х	Н	Х	Х	Х	Х	L	Н
L	Н	L	L	Х	Х	Х	Х	L	Х	Х	Х	Н	L
L	Н	L	L	Х	Х	Х	Х	Н	Х	Х	Х	L	Н
L	Н	L	Н	Х	Х	Х	Х	Х	L	Х	Х	Н	L
L	Н	L	Н	Х	Х	Х	Х	Х	Н	Х	Х	L	Н
L	Н	Н	L	Х	Х	Х	Х	Х	Х	L	Х	Н	L
L	Н	Н	L	Х	Х	Х	Х	Х	Х	Н	Х	L	Н
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	L	Н	L
L	Н	Н	Н	Х	Х	Х	Х	Х	Х	Х	Н	L	Н

# 7. Limiting values

#### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$	-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$	-	±25	mA
I <sub>CC</sub>	supply current		-	+50	mA
$I_{GND}$	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb}$ = -40 °C to +125 °C [1]	-	500	mW

<sup>[1]</sup> For SOT109-1 (SO16) package:  $P_{tot}$  derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

# 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC251		7	Unit		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

# 9. Static characteristics

#### **Table 6. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC25	1									
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>								
	output voltage	I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL};$ $V_O = V_{CC} \text{ or GND};$ $V_{CC} = 6.0 \text{ V}$	-	-	±0.5	-	±5.0	-	±10.0	μA
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	8.0	-	80	-	160	μA
Cı	input capacitance		-	3.5	-					pF
74HCT2	51			'			'	1	-	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5 \text{ V}$								
	output voltage	Ι <sub>Ο</sub> = 20 μΑ	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_O = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.5	-	±5.0	-	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	-	80	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	$V_I = V_{CC}$ - 2.1 V; other inputs at $V_{CC}$ or GND; $V_{CC}$ = 4.5 V to 5.5 V; $I_O$ = 0 A								
		per input pin; In inputs	-	100	360	-	450	-	490	μA
		per input pin; OE input	-	150	540	-	675	-	735	μA
		per input pin; Sn input	-	150	540	-	675	-	735	μA
Cı	input capacitance		-	3.5	-					pF

# 10. Dynamic characteristics

#### **Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V);  $C_L$  = 50 pF unless otherwise specified; for test circuit, see Fig. 9.

Symbol	Parameter	Conditions		25 °C		-40 °C t	o +85 °C	-40 °C to	Unit	
			Min	Тур	Max	Min	Max	Min	Max	
74HC25	1				1	I .	'	<u> </u>		
t <sub>pd</sub>	propagation	In to Y; see Fig. 6	1]							
	delay	V <sub>CC</sub> = 2.0 V	-	50	170	-	215	-	255	ns
		V <sub>CC</sub> = 4.5 V	-	18	34	-	43	-	51	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	29	-	37	-	43	ns
		In to ₹; see Fig. 6	1]							
		V <sub>CC</sub> = 2.0 V	-	55	175	-	220	-	265	ns
		V <sub>CC</sub> = 4.5 V	-	20	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	17	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	16	30	-	37	-	45	ns
		Sn to Y; see Fig. 7	1]							
		V <sub>CC</sub> = 2.0 V	-	66	205	-	255	-	310	ns
		V <sub>CC</sub> = 4.5 V	-	24	41	-	51	-	62	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	20	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	19	35	-	43	-	53	ns
		Sn to $\overline{Y}$ ; see $\underline{\text{Fig. 7}}$	1]							
		V <sub>CC</sub> = 2.0 V	-	69	205	-	255	-	310	ns
		V <sub>CC</sub> = 4.5 V	-	25	41	-	51	-	62	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	21	-	-	-	-	-	ns
		V <sub>CC</sub> = 6.0 V	-	20	35	-	43	-	53	ns
t <sub>en</sub>	enable time	OE to Y, ∀; see Fig. 8	2]							
		V <sub>CC</sub> = 2.0 V	-	36	140	-	175	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	13	28	-	35	-	42	ns
		V <sub>CC</sub> = 6.0 V	-	10	24	-	30	-	36	ns
t <sub>dis</sub>	disable time	OE to Y, Y; see Fig. 8	3]							
		V <sub>CC</sub> = 2.0 V	-	39	140	-	170	-	210	ns
		V <sub>CC</sub> = 4.5 V	-	14	28	-	35	-	42	ns
		V <sub>CC</sub> = 6.0 V	-	11	24	-	30	-	36	ns
t <sub>t</sub>	transition	Y, \overline{Y}; see Fig. 6	4]							
	time	V <sub>CC</sub> = 2.0 V	-	19	75	-	95	-	110	ns
		V <sub>CC</sub> = 4.5 V	-	7	15	-	19	-	22	ns
		V <sub>CC</sub> = 6.0 V	-	6	13	-	16	-	19	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f = 1 MHz; $V_I$ = GND to $V_{CC}$	5] -	44	-	-	-	-	-	pF

Symbol	Parameter	Conditions			25 °C		-40 °C t	o +85 °C	-40 °C to	o +125 °C	Unit
				Min	Тур	Max	Min	Max	Min	Max	
74HCT2	51								<u> </u>		
t <sub>pd</sub>	propagation	In to Y; see Fig. 6	[1]								
	delay	V <sub>CC</sub> = 4.5 V		-	22	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	19	-	-	-	-	-	ns
		In to ₹; see Fig. 6	[1]								
		V <sub>CC</sub> = 4.5 V		-	22	35	-	44	-	53	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	19	-	-	-	-	-	ns
		Sn to Y; see Fig. 7	[1]								
		V <sub>CC</sub> = 4.5 V		-	24	44	-	55	-	66	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	20	-	-	-	-	-	ns
		Sn to ₹; see Fig. 7	[1]								
		V <sub>CC</sub> = 4.5 V		-	25	44	-	55	-	66	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	21	-	-	-	-	-	ns
t <sub>en</sub>	enable time	OE to Y, Y; see Fig. 8	[2]								
		V <sub>CC</sub> = 4.5 V		-	13	28	-	35	-	42	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	13	-	-	-	-	-	ns
t <sub>dis</sub>	disable time	OE to Y, Y; see Fig. 8	[3]								
		V <sub>CC</sub> = 4.5 V		-	14	28	-	35	-	42	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF		-	18	-	-	-	-	-	ns
t <sub>t</sub>	transition	Y, ₹; see Fig. 6	[4]								
	time	V <sub>CC</sub> = 4.5 V		-	7	15	-	19	-	22	ns
C <sub>PD</sub>	power dissipation capacitance	$C_L$ = 50 pF; f = 1 MHz; V <sub>I</sub> = GND to V <sub>CC</sub> - 1.5 V	[5]	-	46	-	-	-	-	-	pF

- $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2] t<sub>en</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>.

- ten is the same as t<sub>PLZ</sub> and t<sub>PLZ</sub>.
   t<sub>dis</sub> is the same as t<sub>PLZ</sub> and t<sub>PHZ</sub>.
   t<sub>t</sub> is the same as t<sub>THL</sub> and t<sub>TLH</sub>.
   C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).
   P<sub>D</sub> = C<sub>PD</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>i</sub> × N + ∑(C<sub>L</sub> × V<sub>CC</sub><sup>2</sup> × f<sub>o</sub>) where:

 $f_i$  = input frequency in MHz;

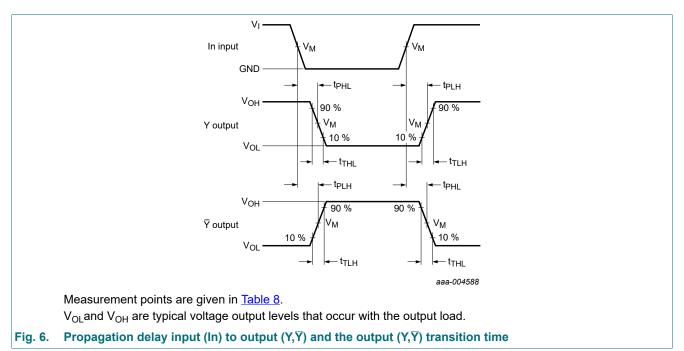
f<sub>o</sub> = output frequency in MHz;

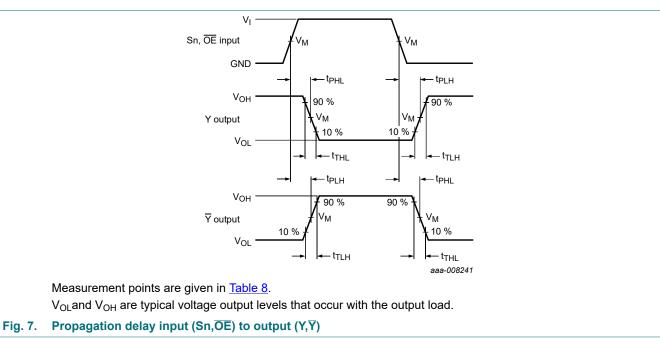
C<sub>L</sub> = output load capacitance in pF;

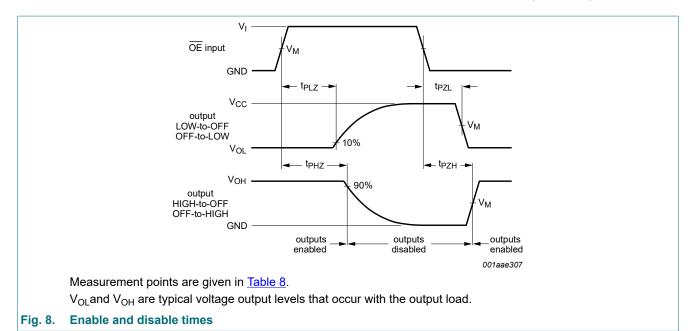
V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;  $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of outputs.}$ 

#### 10.1. Waveforms and test circuit

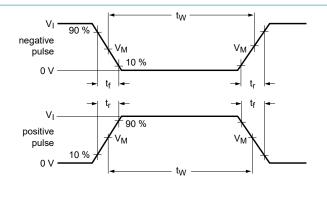


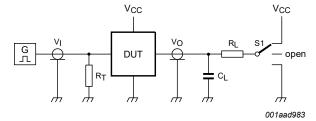




**Table 8. Measurement points** 

rable of incacaronions points		
Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC251	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT251	1.3 V	1.3 V





Test data is given in Table 9.

Definitions test circuit:

 $R_T$ = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

C<sub>L</sub>= Load capacitance including jig and probe capacitance.

 $R_I$  = Load resistance.

S1 = Test selection switch.

#### Fig. 9. Test circuit for measuring switching times

Table 9. Test data

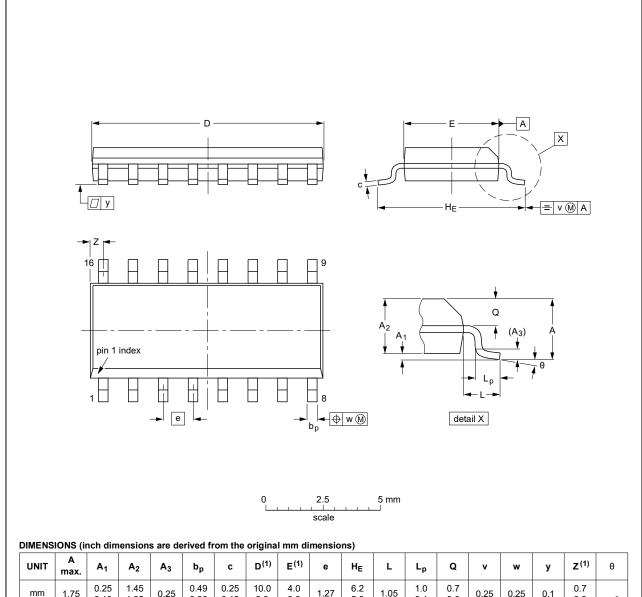
Туре	Input		Load		S1 position				
	$V_{l}$	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$		
74HC251	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>		
74HCT251	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>		

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# 11. Package outline

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	<b>A</b> <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

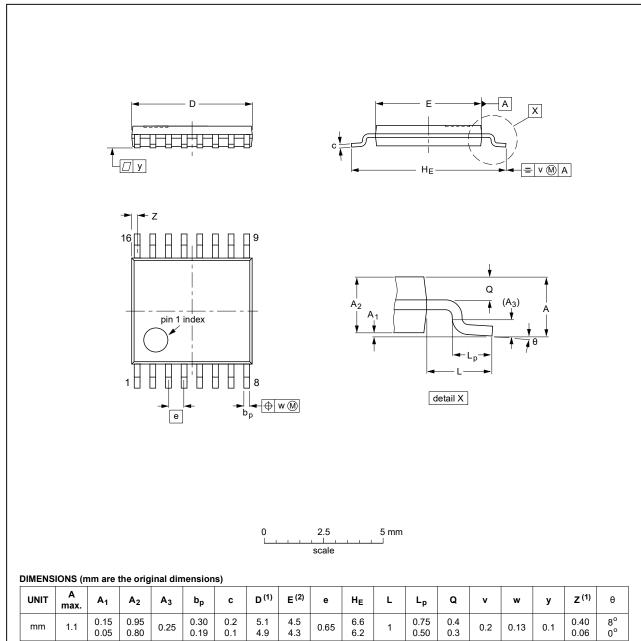
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig. 10. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18

Fig. 11. Package outline SOT403-1 (TSSOP16)

# 12. Abbreviations

#### **Table 10. Abbreviations**

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 13. Revision history

#### **Table 11. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT251 v.6	20210208	Product data sheet	-	74HC_HCT251 v.5
Modifications:	1	dated. rs 74HC251DB and 74HCT ditions for C <sub>PD</sub> have chang	•	,
74HC_HCT251 v.5	20190715	Product data sheet	-	74HC_HCT251 v.4
Modifications:	of Nexperia. • Legal texts h	of this data sheet has been have been adapted to the notating values for P <sub>tot</sub> total po	ew company nam	
74HC_HCT251 v.4	20160201	Product data sheet	-	74HC_HCT251 v.3
Modifications:	Type numbe	rs 74HC251N and 74HCT2	51N (SOT38-4) re	emoved.
74HC_HCT251 v.3	20130709	Product data sheet	-	74HC_HCT251_CNV v.2
Modifications:	guidelines of	this data sheet has been NXP Semiconductors.  Nave been adapted to the new	· ·	
74HC_HCT251_CNV v.2	19970828	Product specification	-	

### 14. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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